

B3 connection to ground may then be formed by means such as riveting, or screwing a soldered joint or even a soldered wire link.

At page 2, at line 7 please insert:

B4 --SUMMARY OF THE INVENTION--.

At page 2, please delete the fourth full paragraph commencing at line 10 and insert therefor:

B5 --To this end, the invention proposes an assembly including a printed-circuit electronics card mounted on a metal substrate, as well as a metal screening cover electrically connected to the substrate, the substrate exhibiting a recessed gutter in which the edge of the cover is accommodated, the edge being crimped onto the substrate in the gutter.

At page 2, please delete the fifth full paragraph commencing at line 17 and insert therefor:

--The invention also proposes a method for producing such an assembly, characterized by the following stages:

- B6
- the substrate is stamped so as to form a gutter in it,
 - the electronics card is assembled onto the substrate,
 - the cover is positioned on the assembly thus obtained, arranging the edge of the cover in

the gutter,

- the edge is crimped onto the substrate.

At page 2, at line 32 please insert:

B7 --BRIEF DESCRIPTION OF THE DRAWINGS--.

At page 3, at line 10 please insert:

B8 --DETAILED DESCRIPTION OF THE INVENTION--.

At page 3, please delete the fourth full paragraph commencing at line 13 and insert therefor:

B9 --The substrate 1 has a recessed gutter 4 produced by stamping the material. This gutter 4 extends over the substrate along a contour which corresponds to that of the edge of the metal cover 3.--

At page 3, please delete the seventh full paragraph commencing at line 21 and insert therefor:

B10 --To this end, the edge is extended by one or more tabs 5, which form an L-shaped return extending outwards from the cover 3.--

At page 3, please delete the eighth full paragraph commencing at line 24 and insert therefor:

B11 --Such a tab 5 is accommodated in a region of the gutter 4 which is stamped with a width which coincides with that of the tab 5. Hence, the tab 5 is inserted exactly into the recessed shape of the gutter 4.--

At page 4, please delete the third full paragraph commencing at line 7 and insert therefor:

B12 --When the cover 3 is correctly positioned, localized crimping is carried out, by lateral displacement of the material of the substrate on top of the corners of the tabs 5 of the cover 3. The material displaced during the crimping is that which forms the edges of the gutter originating from the stamping. More particularly, as Figures 2a and 2b illustrate, the material pushed back by the stamping during the formation of the gutter exerts on the tabs 5, after crimping, parallel forces canceling each other out. The material displaced during the crimping is referenced by 6.--

At page 4, please delete the fifth full paragraph commencing at line 24 and insert